2002/010

Appl. No. 10/614,807

OCT 1 9 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No	10/614.807
Filing Date	July 9, 2003
Inventor	Wuwen Yi et al.
Assignee	
Group Art Unit	1742
Examiner	
Attorney's Docket No	
Customer No	
Title: Copper Sputtering Targets and Methods of Forming Copper Sputtering Targets	

RESPONSE TO SEPTEMBER 20, 2005 OFFICE ACTION

To:

Mail Stop Amendment Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

From:

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AMENDMENTS

Introductory Comments

In reply to the Office Action of September 20, 2005, applicant amends and remarks as follows.